

Title (en)

METHOD AND DEVICE FOR PRODUCING A METALLIC STRIP

Title (de)

VERFAHREN UND VORRICHTUNG ZUM HERSTELLEN EINES METALLISCHEN BANDES

Title (fr)

PROCÉDÉ ET DISPOSITIF DE FABRICATION D'UNE BANDE MÉTALLIQUE

Publication

EP 4122615 B1 20231213 (DE)

Application

EP 22184469 A 20220712

Priority

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Abstract (en)

[origin: JP2023016726A] To provide a method for manufacturing a metal band material that rolls a band material from a slab 3 using a plurality of rolling stands in a rolling line, and connects individual partial slabs to be rolled from the individual partial slabs 3a and 3b by a slab joint device 4, which separates a part 5 of the partial slab 3a positioned in front in a rolling direction R and a part of the partial slab 3b positioned backward in the rolling direction in the slab joint device, and joins both of the slabs in a separation part 6, enables improved monitoring of a slab manufacturing process and can quickly react defects in a coarsely rolled product (slab or coarsely rolled material).SOLUTION: At least one of both of partial slab 3a and 3b is measured in a separation part 6 before joining after both of the partial slabs are separated.SELECTED DRAWING: Figure 2

IPC 8 full level

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